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Assessment of Large Critical Electric Field in Ultra-wide Bandgap *p*-type Spinel ZnGa_2O_4

Zeyu Chi¹, Tamar Tchelidze², Corinne Sartel¹, Tshotne Gamsakhurdashvili²,
Ismail Madaci¹, Hayate Yamano³, Vincent Sallet¹, Yves Dumont¹,
Amador Pérez-Tomás⁵, Farid Medjdoub⁴, Ekaterine Chikoidze*¹

¹Groupe d'Etude de la Matière Condensée (GEMaC), Université Paris-Saclay, UVSQ – CNRS, 45
Av. des Etats-Unis, 78035 Versailles Cedex, France

²Faculty of Exact and Natural Science, Department of Physics, Ivane Javakhishvili Tbilisi State
University, 3 Av. Tchavtchavadze, 0179 Tbilisi, Georgia

³Department for Integrated Sensor Systems, Danube University Krems, 3500 Krems, Austria

⁴IEMN, CNRS, UMR8520, Av. Poincare, 59650, Villeneuve D'Ascq, France

⁵Catalan Institute of Nanoscience and Nanotechnology (ICN2), CSIC and The Barcelona Institute
of Science and Technology, Barcelona, Spain

Correspondence author: ekaterine.chikoidze@uvsq.fr

Abstract:

The spinel Zinc gallate ZnGa_2O_4 stands out among the emerging ultra-wide bandgap (~ 5 eV) semiconductors as the ternary complex oxide with the widest gap where bipolar conductivity has been demonstrated. For power and energy electronics, a fundamental property of the material is its critical electric field (E_{CR}) although, for ZnGa_2O_4 , is yet unknown. In this work, highly resistive *p*-type ZnGa_2O_4 thin films on sapphire and Si substrates were grown by metal organic chemical vapor deposition (MOCVD) to determine both, the remote acceptor concentration and vertical breakdown voltage. Hall Effect measurements confirmed a low carrier concentration at room temperature of $\sim 10^{11} \text{ cm}^{-3}$. From vertical metal-semiconductor-metal structures the average E_{CR} has been estimated to be of at least 5.3 MV/cm, which already is significantly larger than the one of SiC and GaN.

Keywords: ultra-wide band gap, ZnGa_2O_4 , electrical properties, critical electric field

1. Introduction

Ultra-wide bandgap (UWBG) semiconductor oxides have recently attracted significant attention as a novel platform for ultra-high power electronics and deep ultraviolet opto-electronics [1]. The spinel zinc gallate (ZnGa_2O_4) stands out within the family of oxide UWBG ($E_g \sim 5$ eV) as an advanced semiconductor platform for applications such as photonics (i.e. photodetector [2], phototransistors [3–5]), gas sensors [6], thin-film-transistors [7–9], or optical memory application [10], thus, heralding novel spinel electronics. Spinel oxides have, indeed, a peculiar chemical formula AB_2O_4 , where A and B cations occupy octahedral (O_h) and tetrahedral (T_d) sites formed by oxygen atoms. Thus, spinel oxides obey different doping rules from traditional binary semiconductor oxides because of their multivalent elements and different sites, such as the antisite defects due to the inverted distribution of cations [11]. The disordered distribution of ions and vacancies in the material, (caused by the so-called self-doping effect), can lead to intrinsic electron or hole conductivity [12].

Consequently, a wide range of intrinsic conductivities have been reported for ZnGa_2O_4 . The resistivity of native n - ZnGa_2O_4 can be as low as $2.7 \times 10^{-2} \Omega \cdot \text{cm}$ at room temperature (e.g., [7,13]), while intrinsic p - ZnGa_2O_4 is, in general, rather insulating at room temperature. Indeed, Chikoidze *et al.* [14] reported native p -type ZnGa_2O_4 thin films grown by metal organic chemical vapor deposition (MOCVD), where the intrinsic hole conductivity at high temperature was attributed to the antisite defects Zn_{Ga} . Therefore, the intrinsic conductivity of ZnGa_2O_4 thin films can be controlled well over 10 orders of magnitude by tuning the growth conditions (cation ratio, oxygen pressure, etc.) thanks to this self-doping effect [15]. In agreement with these empirical observations, Sabino *et al.* [16] suggested by ab-initio simulations that both, n - and p -type conductivities could be achieved in ZnGa_2O_4 , and the hole conductivity is likely achieved by a polaronic band due to excess of Zn. It should be noted, however, that the electronic and optoelectronic devices based on ZnGa_2O_4 , are mostly unipolar (i.e., n -type) (e.g. [17]) and studies on p -type ZnGa_2O_4 devices are still very limited. However, to exploit the full potential of ZnGa_2O_4 spinel electronics, bipolar devices (such as p - n junction (photo) diodes, PiN rectifiers, lateral and vertical power MOSFETs) and p -type conductivity should be achieved.

The critical electric field (E_{CR}) of a material is a crucial parameter for assessing a semiconductor material's potential as a platform for power and energy electronics applications. In particular, the Baliga's figure of merit [18] is informative of the on-state/blocking device performance for power switching applications which primarily depends on carrier mobility and the cube of the critical electric field. Representative values of the critical electric field for the most common power electronics semiconductors, such as silicon (0.3 MV/cm), 4H-SiC (3.5 MV/cm) [19], GaN (3.9 MV/cm) [20], or AlGaN (5.9 MV/cm [21]) are well known. For other UWBG such as AlN, the E_{CR} values have also been reported (12 MV/cm [22]) while a generally agreed theoretical value for diamond is 10 MV/cm [23]. For β - Ga_2O_3 , a common estimation for the upper limit given in the literature is ~ 8 MV/cm [24], while this value may be well underestimated as it has recently been experimentally observed to be at least 8.32 MV/cm and 13.2 MV/cm for p -NiO/ β - Ga_2O_3 junctions [25] and Zn-doped β - Ga_2O_3 [26], respectively). However, to the best of our knowledge, critical electric field values for ZnGa_2O_4 are not yet known.

Therefore, the objective of the present work was to define ZnGa₂O₄ thin films onto insulating and conducting substrates for assessing the remote concentration and to establish a preliminary value of the ZnGa₂O₄ critical electric field, respectively. According to the kinetic impact ionization theory and previous studies on Ga₂O₃ [26], to achieve large critical electric fields, it is mandatory to obtain a sample with low remote carrier concentration to reduce the onset of the impact ionization process. In the present work, we studied ZnGa₂O₄ thin films, which are highly resistive *p*-type in nature due to their deep acceptor native defects as we will show further on.

2. Experimental details

ZnGa₂O₄ thin films were grown in a radio-frequency (RF) heated horizontal MOCVD reactor with separate inlets to avoid premature reactions in the manifold between oxygen and organometallic precursors. Trimethylgallium (TMGa), diethylzinc (DEZn) and, 5.5 N pure oxygen were used as gallium, zinc, and oxygen sources, respectively. The TMGa and DEZn bubbler temperatures were fixed at -10°C and 0°C, respectively. During the growth, the flow rates of TMGa, DEZn, and oxygen were kept at 11 μmol/min, 7 μmol/min, and 1200 sccm, respectively. The growth temperature and the reactor pressure were set at 775°C, and 38 torr, respectively. The growth time was 90 minutes. Argon was used as carrier gas. To analyse the ZnGa₂O₄ crystal phases, X-Ray diffraction profiles were recorded in $\theta/2\theta$ configuration between 15° and 115°, using a Rigaku SmartLab apparatus equipped with a Cu-K α source ($\lambda = 0.1541$ nm). The thicknesses of the thin films were determined by means of scanning electron microscopy (SEM) cross-sectional images from a JEOL JSM 7001F scanning electron microscope.

For Hall effect measurements, Ohmic contacts were prepared with silver paint at the four corners of the sample. The resistivity and Hall effect measurements were performed, in a Van der Pauw configuration with perpendicularity to current applied magnetic fields varying from 0 to 1.6 T, in 550 to 850 K temperature range. The majority charge carrier sign, concentration, and mobility were then determined. A Keysight B1505A Power Device Analyzer has been used to carry out the vertical breakdown voltage measurements at room temperature. Negative bias has been applied on an isolated Ohmic contact with the grounded substrate to access the breakdown voltage.

3. Results and discussion

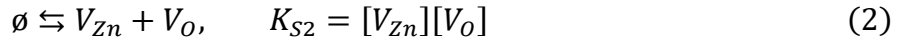
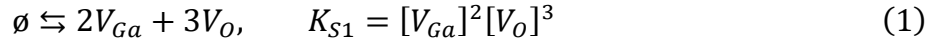
3.1. Thermodynamic Analysis of Point Defects and Free Carriers

We conducted a thermodynamic analysis of point defects and free carriers for equilibrium condition to establish the optimal growth parameters of the ZnGa₂O₄ close to the stoichiometry composition. This thermodynamic analysis is carried out for the ZnGa₂O₄ (crystal) - O₂ (gas) system. It is a three-component two-phase system. Thus, according to Gibbs' phase rule, its degree of freedom is 3, so three thermodynamic parameters can vary freely. All material

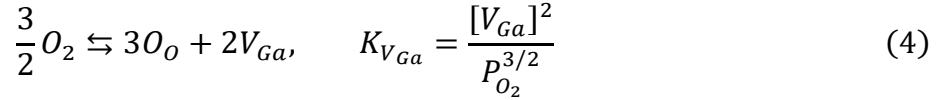
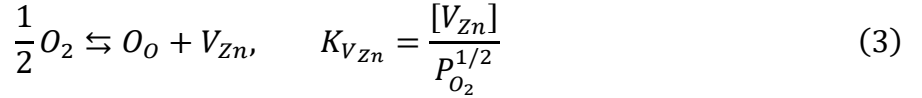
properties, including defects, free carriers' concentrations, and conductivity, depend on them. We chose the following independent variables: temperature T , oxygen partial pressure P_{O_2} , and the ratio of gallium and zinc partial pressures $x = \frac{P_{Ga}}{P_{Zn}}$.

To find the dependence of concentrations of defects and free carriers on these parameters we used the Kroger method of quasi-chemical reactions [27]. Special attention is paid to discern if the concentration of antisite defects Ga_{Zn} and Zn_{Ga} can be controlled in such a way to impact n - and p -type conductivities. The processes we considered with the corresponding mass action law are the following:

The creation of a Schottky defect pairs:



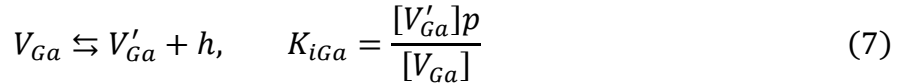
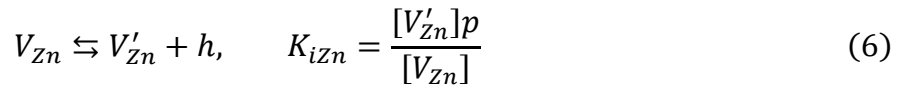
Where V_{Zn} , V_{Ga} , and V_O are zinc, gallium, and oxygen vacancies, respectively; $[V_{Zn}]$, $[V_{Ga}]$, and $[V_O]$ are their concentrations, respectively. The incorporation of oxygen atoms in a crystal from the surrounding atmosphere, when zinc and gallium vacancies are created:



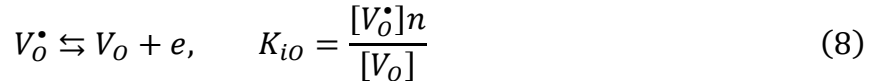
The lattice thermal ionization:



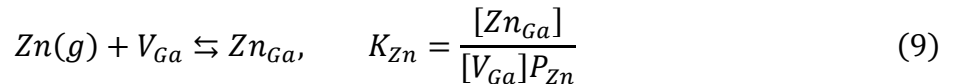
Where e and h are electrons and holes, respectively; n and p are their concentrations, respectively. The ionization of zinc, gallium and oxygen vacancies:

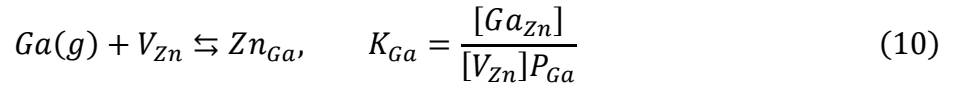


Where V'_{Zn} and V'_{Ga} denote positively single-charged zinc and gallium vacancies, respectively; $[V'_{Zn}]$ and $[V'_{Ga}]$ are their concentrations, respectively. The ionization of oxygen vacancy:

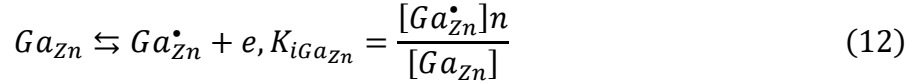
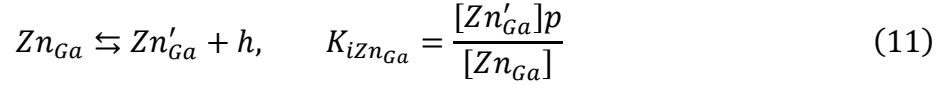


Where V_O^\bullet denotes negatively single-charged oxygen vacancy; $[V_O^\bullet]$ is its concentration. Creation of antisite defects via incorporation of metal atoms from the gas phase into vacancies:





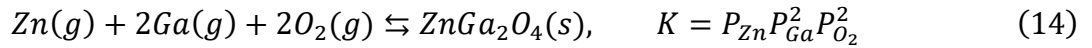
Where Zn_{Ga} and Ga_{Zn} are zinc in gallium site and gallium in zinc site anti-site defects, respectively; $[Zn_{Ga}]$ and $[Ga_{Zn}]$ are their concentrations, respectively. And their ionizations:



Where Zn'_{Ga} and Ga^*_{Zn} are positively and negatively single-charged anti-site defects, respectively; $[Zn'_{Ga}]$ and $[Ga^*_{Zn}]$ their concentrations, respectively. To find the concentration of defects and free carriers by the system of equations (1) - (12), the charge neutrality condition must be added:

$$n + [V'_{Zn}] + [V'_{Ga}] + [Zn'_{Ga}] \rightleftharpoons p + [V^*_O] + [Ga^*_{Zn}] \quad (13)$$

The connection between zinc, gallium, and oxygen partial pressures are defined by means of the constant of the zinc gallate creation reaction:



Having solved the system of equations (1) - (14), one can find the concentrations of defects and free carriers versus temperature, partial pressure of one component and ratio of gallium and zinc pressures. The calculated concentrations of charged defects and free carriers in dependence of oxygen partial pressure are shown in Figure 1. The temperature was chosen to be 775 °C, the ratio $x = \frac{P_{Ga}}{P_{Zn}}$ equals to 3. These parameters correspond to our actual growth conditions. The $x = P_{Ga}/P_{Zn}$ ratio is roughly estimated on the base of TMGa and DEZn flow rates and their formation enthalpies:

$$x = \frac{P_{Ga}}{P_{Zn}} = \frac{J_{Ga}\sqrt{2m_{Ga}kT} \exp(-\Delta H_{Ga}/kT)}{J_{Zn}\sqrt{2m_{Zn}kT} \exp(-\Delta H_{Zn}/kT)}$$

Here J_{Ga} and J_{Zn} are flow rates of TMGa and DEZn, respectively, m_{Ga} and m_{Zn} masses of Ga and Zn atoms, ΔH_{Ga} and ΔH_{Zn} formation enthalpies of TMGa and DEZn.

One can distinguish the following regions in the figure that:

- I. The region of intrinsic n -conductivity, origin of which are oxygen vacancies V_O . In this region $[V^*_O] = n$, and they are dominant;
- II. The first region of self-compensation, here oxygen vacancies $[V^*_O]$ and zinc vacancies $[V'_{Zn}]$ are dominant species and $[V^*_O] = [V'_{Zn}]$;
- III. The second region of self-compensation where zinc vacancies $[V'_{Zn}]$ and gallium in zinc sites $[Ga^*_{Zn}]$ are dominant, and $[V'_{Zn}] = [Ga^*_{Zn}]$. In this region, the concentration of holes exceeds the concentration of electrons significantly. Around $P_{O_2} = 1 \text{ atm}$, the concentration of holes achieves 10^{15} cm^{-3} . It is remarkable that the concentration of holes at a whole range of pressure tails negatively charged gallium vacancies $[V'_{Ga}]$ - the concentrations of V'_{Ga} and holes change

the same way when oxygen partial pressure changes and difference between these concentrations is quite small along the whole pressure range.

- IV. The region of hole conductivity, here $[V'_{Ga}]$ and holes are dominant species. However, the oxygen pressure is unrealistically high here.

Notably, there is a very weak dependence of concentrations of free carriers on x . For $x = 10^{-3}$, that is, when the partial pressure of Zn exceeds the partial pressure of Ga three orders of magnitude, the concentration of holes increases only ten times, compared to $x = 3$.

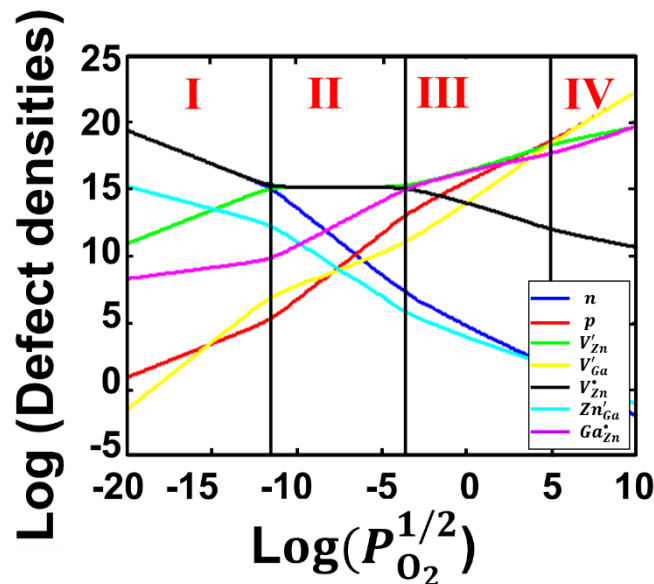


Figure 1. The dependence of concentration of point defects and free carriers on oxygen partial pressure, for $T = 775$ °C, and $x = \frac{P_{Ga}}{P_{Zn}} = 3$.

Therefore, the growth of both n - and p -type $ZnGa_2O_4$ thin films are feasible by tuning the growth parameters such as, mainly oxygen partial pressure and temperature. The cations concentration ratio weakly affects the conductivity (as experimentally observed [14]). In this work, we concentrate on the regions predicted to correspond to p -type conductivity. Then, the highly-resistive p -type $ZnGa_2O_4$ thin layer was grown in the conditions which are input from thermodynamic analysis.

3.2. $ZnGa_2O_4$ Thin Film Growth and Structural Properties

$ZnGa_2O_4$ thin films were grown on two kinds of substrates simultaneously: on conducting p -type Si(111) and c-oriented sapphire $Al_2O_3(0001)$ (insulating) substrates. $ZnGa_2O_4/Si$ sample was used to fabricate vertical parallel plane capacitors, and characterized vertically for breakdown voltage capability. While the $ZnGa_2O_4/sapphire$ thin film was used for the investigation of the electrical transport properties (resistivity, carrier, mobility) at elevated temperatures in a Van Der Pauw configuration.

Figure 2 shows the Cu-K α X-ray diffraction (XRD) spectra of $ZnGa_2O_4$ thin films grown on Si(111) and $Al_2O_3(0001)$. According to the PDF 28-1240 file, it is pure $ZnGa_2O_4$ spinel without a secondary phase. Film on Si(111) is polycrystalline without any preferential texturization, similar to

XRD pattern reported by Galazka *et al.* [28] for their melt-grown bulk ZnGa_2O_4 spinel, milled in a randomly oriented powder. For films on $\text{Al}_2\text{O}_3(0001)$ substrates, Bragg peaks appearing at 18.6° , 37.6° , 57.6° , 79.7° , and 106.6° correspond to the (111), (222), (333), (444), and (555) planes of the cubic spinel ZnGa_2O_4 , respectively, as reported by previous literature [14,29].

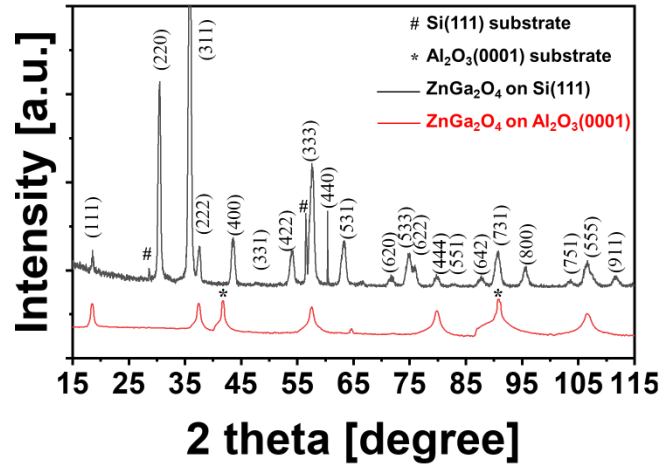


Figure 2. *Cu-K α* XRD spectra of ZnGa_2O_4 thin film grown on Si(111) (black), and $\text{Al}_2\text{O}_3(0001)$ (red). * and # correspond respectively to $\text{Al}_2\text{O}_3(0001)$ and Si(111) Bragg reflections.

ZnGa_2O_4 thin films have already been grown polycrystalline on sapphire substrates by MOCVD [30], radio-frequency (RF) magnetron sputtering [31,32], pulsed laser deposition (PLD) [13], with a preferential orientation along [111] of cubic spinel and equivalent direction for $\text{Al}_2\text{O}_3(0001)$. Analogously, ZnGa_2O_4 thin films have also been grown on Si substrates by atomic layer deposition (ALD) [29], PLD [33], and RF magnetron sputtering [32]. A larger lattice mismatch between ZnGa_2O_4 and Si(100) (which may also contain a native ultra-thin SiO_2 interlayer) results in a relatively weaker orientation of crystallite in the ZnGa_2O_4 grown on Si substrate than that on sapphire (0001) [32]. The full width at half maximum (FWHM) values were measured as 0.29° and 0.49° for ZnGa_2O_4 (111) on sapphire and Si(100) substrates, respectively, indicating also a smaller size of crystallites in the case of Si(111) substrates with respect to $\text{Al}_2\text{O}_3(0001)$ ones.

3.3. Electrical Transport Properties

Hall and electrical transport properties were studied for ZnGa_2O_4 grown on Al_2O_3 crystals, as the sapphire substrate is insulating up to high temperatures thus preventing parasitic leakage through the substrate. Figure 3-a shows a typical Ohmic current–voltage (I–V) behavior at different temperatures. The ohmic contact was made with silver paste painted at four corners of the sample in a square shape. The resistivity versus temperature for the spinel ZnGa_2O_4 sample is shown in Figure 3-b. At 850 K, the resistivity was measured as $1.9 \times 10^2 \Omega \cdot \text{cm}$, and increased to $5.3 \times 10^4 \Omega \cdot \text{cm}$ at 550 K. Hall voltage (V_H) versus magnetic field (0 – 1.6 T) at 700 – 850 K for a ZnGa_2O_4 sample is shown in Figure 3-c, the positive V_H increases with a perpendicularly applied magnetic field in a Van der Pauw configuration, which evidenced that our spinel ZnGa_2O_4 thin film has *p*-type conductivity at elevated temperature. The temperature dependence for Hall hole concentration is shown in Figure 3-d for *p*-type ZnGa_2O_4 film, the hole concentration was measured between 8.8×10^{11} and $3.7 \times 10^{15} \text{ cm}^{-3}$.

³ at 550 – 850 K. Although the hopping behavior starts to pronounce below 600 K, extrapolating the band-activated regime of the hole concentration versus temperature at the higher temperatures, the hole density is below 10^{11} cm^{-3} at 300 K, confirming the low level of p -type doping with the applied growth conditions. The mobility of the p -type ZnGa_2O_4 thin film varies between 9 and $15 \text{ cm}^2/(\text{V}\cdot\text{s})$.

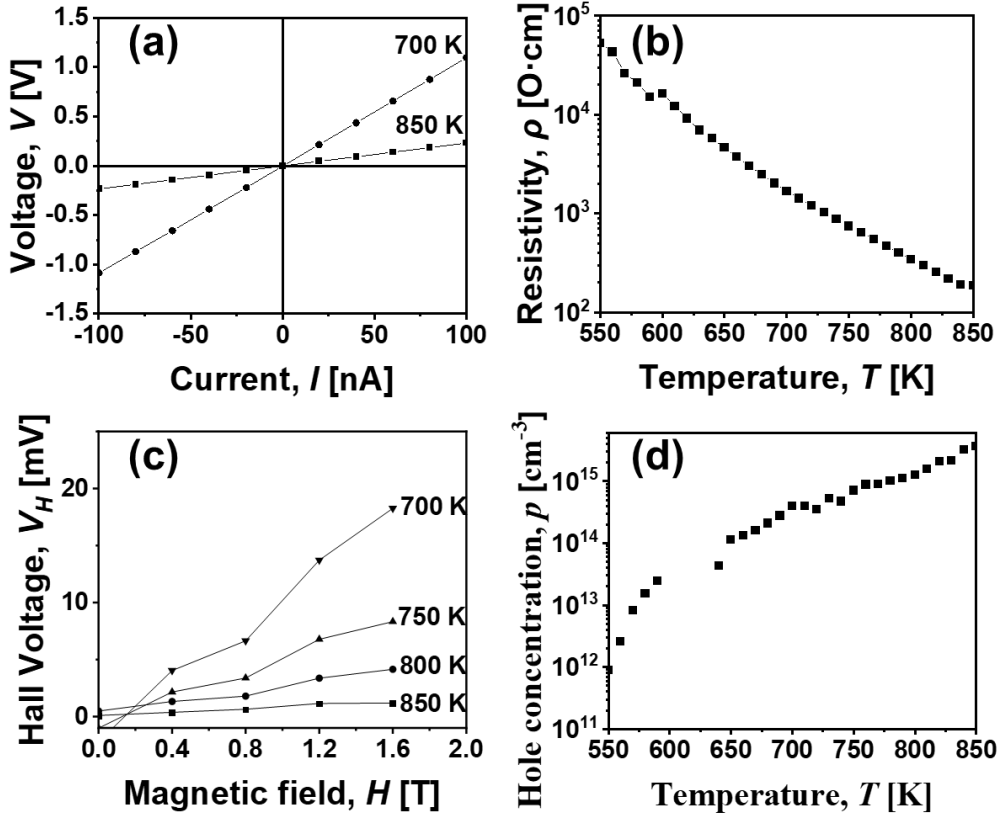


Figure 3. (a) Ohmic I – V characteristics at 700K and 850 K (b) Resistivity versus temperature. (c) Hall voltage (V_H) versus magnetic field at different temperatures (700 – 850 K). The Hall voltage is positive and increase with the increasing applied magnetic field, indicating the p -type conductivity in ZnGa_2O_4 layer. (d) Temperature dependence for Hall free hole concentration for ZnGa_2O_4 thin film.

3.4. ZnGa_2O_4 Critical Electric Field

To determine the vertical critical electric field experimentally, vertical parallel plane capacitors has been fabricated by depositing Ti/Au contacts (with a size of $170 \mu\text{m} \times 300 \mu\text{m}$) onto p -type ZnGa_2O_4 grown onto the conducting Si thin films (Figure 4-a). Figure 4-b shows the scanning electron microscopy (SEM) cross-section image revealing that the thickness of the $\text{ZnGa}_2\text{O}_4/\text{Si}$ is 600 nm.

The vertical hard breakdown voltage V_{BR} was in the range of 270 to 350 V (Figure 4-c). It can be pointed out that a low leakage current below $1 \text{ mA}/\text{mm}^2$ is observed all the way to the breakdown voltage. A thin SiO_2 layer (2 nm) at the interface $\text{ZnGa}_2\text{O}_4/\text{Si}$ can often be seen [32] after the growth. To exclude the influence of the SiO_2 layer, a bare Si substrate with a native SiO_2 (2 – 3 nm thick layer) has been characterized as well. The vertical breakdown voltage of around 10 V [26] is considered to produce a negligible contribution to the experimentally measured V_{BR} of p -type $\text{ZnGa}_2\text{O}_4/\text{Si}$ structure.

Taking the experimentally determined 600 nm thickness for the ZnGa_2O_4 layer and extracting bare Si substrate related V_{BR} into account, the average vertical critical electric field across the film can be as high as $E_{CR} = 5.3$ MV/cm, which is already significantly larger than the one from SiC and (single crystal) GaN. Therefore, the blank of breakdown field for ZnGa_2O_4 in the literature for assessing WBG semiconductors [34] can be filled as shown in **Table I**.

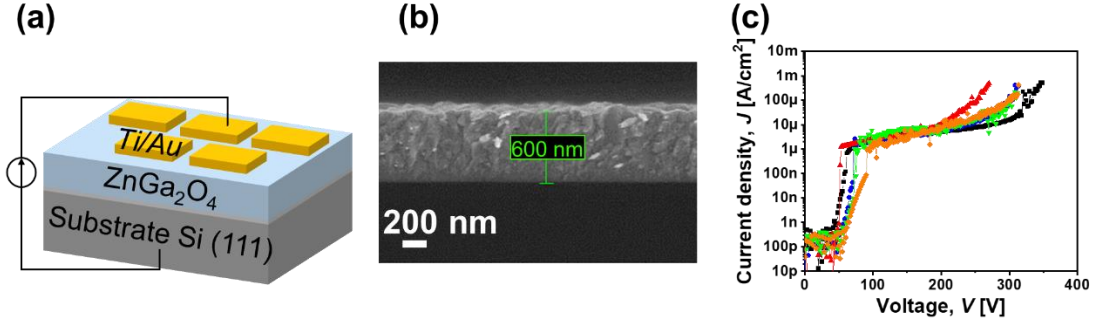


Figure 4. (a) Sketch of the vertical heterojunction structure with Ti/Au metal contacts. (b) SEM cross-section image of ZnGa_2O_4 polycrystalline film deposited on Si(111). The estimated thickness of the film is 600 nm. (c) Experimental I-V curves of vertical breakdown voltage measurements through the $\text{ZnGa}_2\text{O}_4/\text{Si}$ structure, indicating a hard breakdown voltage up to 350 V at room temperature.

Table I. Comparison of various wide-bandgap semiconductor materials properties [26,34,35]. *: experimental E_{CR} values measured by authors. ^aCommon value form literature. ^b $p\text{-NiO}/n\text{-Ga}_2\text{O}_3$ [25] ^c $p\text{-Ga}_2\text{O}_3$ [22]

	4H-SiC	GaN	$\beta\text{-Ga}_2\text{O}_3$	ZnGa_2O_4
Crystal Structure	Hexagonal (Wurtzite)	Hexagonal (Wurtzite)	Monoclinic	Cubic (Spinel)
Space Group	P63mc	P63mc	C2/m	Fd-3m
Direct bandgap, E_g (eV)	3.2	3.4	4.8	4.8
Dielectric constant, ϵ	9.7	9	10 [36]	10.4 [37]
Critical electric field, E_{CR} (MV/cm)	3.5	3.9	8 ^a [24], 8.32 ^b , 5.7 ^c , 13.2 ^c [26]	> 5.3*
Electron mobility, μ ($\text{cm}^2/(\text{V}\cdot\text{s})$)	1000	1250	300	100
Hole mobility, μ ($\text{cm}^2/(\text{V}\cdot\text{s})$)	106 (300 K) [38]	34 (300 K) [39]	~10 (high T) [26]	~10 (high T)
Saturation velocity, v_s (10^7 cm/s)	2	2.5	1.8 – 2	–
Thermal conductivity, λ ($\text{W}/\text{cm}\cdot\text{K}$)	4.9	2.3	0.1 – 0.3	0.22

4. Conclusion

In this work, following a thermodynamic analysis, highly resistive undoped polycrystalline ZnGa_2O_4 thin film of 600 nm were grown on p -type silicon substrate by MOCVD. The conductivity and hole concentration of the film at 550 K were determined to be as low as $5 \times 10^4 \Omega\cdot\text{cm}$ and $9 \times 10^{11} \text{cm}^{-3}$, respectively. The average breakdown voltage of $\text{ZnGa}_2\text{O}_4/\text{Si}$ vertical structures was $V_{BR} = 350$

V, resulting in a critical electric field E_{CR} of 5.3 MV/cm. This value is already near twice the breakdown electrical fields of SiC and GaN and is in line with previous demonstration of its binary counterpart, Ga₂O₃. We believe that this first experimental estimation of E_{CR} for polycrystalline ZnGa₂O₄ will trigger further studies related to nanocrystal and high quality and homo-epitaxial films growth for future possible integration of spinel ZnGa₂O₄ and doped relatives for electronic and optoelectronic devices.

Acknowledgement

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Conflicts of interest

There are no conflicts to declare.

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